Old Company Name in Catalogs and Other Documents

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April 1st, 2010 Renesas Electronics Corporation

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PHOTOCOUPLER PS9121

HIGH CMR, 15 Mbps OPEN COLLECTOR OUTPUT TYPE 5-PIN SOP (SO-5) 3.3 V PHOTOCOUPLER -NEPOC Series-

DESCRIPTION

The PS9121 is an optically coupled high-speed, active low type isolator containing a GaAlAs LED on the input side and a photodiode and a signal processing circuit on the output side on one chip.

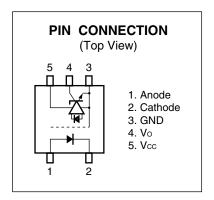
The PS9121 is designed specifically for high common mode transient immunity (CMR) and low pulse width distortion. The PS9121 is suitable for high density application.

FEATURES

- Low power consumption (Vcc = 3.3 V)
- Pulse width distortion (| tPHL tPLH | = 35 ns MAX.)
- High common mode transient immunity (CMH, CML = $\pm 15 \text{ kV}/\mu \text{s MIN.}$)
- Small package (SO-5)
- High-speed (15 Mbps)
- High isolation voltage (BV = 3 750 Vr.m.s.)
- · Open collector output
- Ordering number of taping product: PS9121-F3, F4: 2 500 pcs/reel
- · Pb-Free product
- Safety standards
 - UL approved: File No. E72422
 - DIN EN60747-5-2 (VDE0884 Part2) approved No.40008902 (option)

APPLICATIONS

- Measurement equipment
- PDP
- FA Network



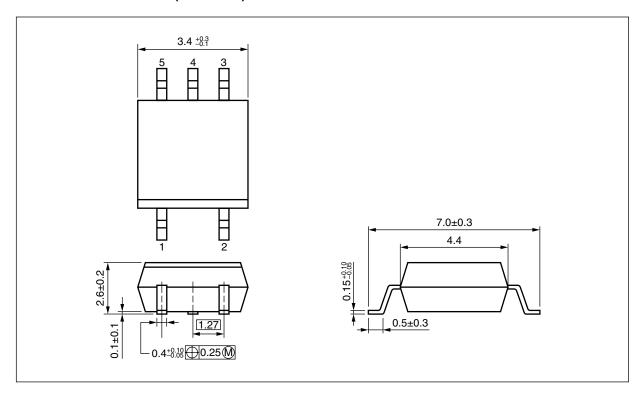
TRUTH TABLE

LED	Output
ON	L
OFF	Н

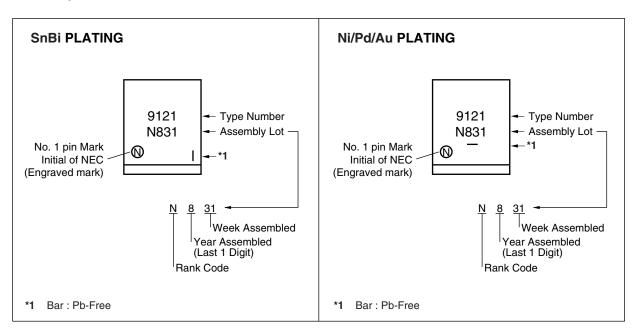
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PACKAGE DIMENSIONS (UNIT: mm)



<R> MARKING EXAMPLE





<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standards Approval	Application Part Number ^{*1}
PS9121	PS9121-A	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	PS9121
PS9121-F3	PS9121-F3-A	(SnBi)	Embossed Tape 2 500 pcs/reel	(UL approved)	
PS9121-F4	PS9121-F4-A				
PS9121-V	PS9121-V-A		20 pcs (Tape 20 pcs cut)	DIN EN60747-5-2	
PS9121-V-F3	PS9121-V-F3-A		Embossed Tape 2 500 pcs/reel	(VDE0884 Part2)	
PS9121-V-F4	PS9121-V-F4-A			approved (Option)	
PS9121	PS9121-AX	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	
PS9121-F3	PS9121-F3-AX	(Ni/Pd/Au)	Embossed Tape 2 500 pcs/reel	(UL approved)	
PS9121-F4	PS9121-F4-AX				
PS9121-V	PS9121-V-AX		20 pcs (Tape 20 pcs cut)	DIN EN60747-5-2	
PS9121-V-F3	PS9121-V-F3-AX		Embossed Tape 2 500 pcs/reel	(VDE0884 Part2)	
PS9121-V-F4	PS9121-V-F4-AX			approved (Option)	

^{*1} For the application of the Safety Standard, following part number should be used.

3



ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current ¹	lF	30	mA
	Reverse Voltage	VR	5	٧
Detector	Supply Voltage	Vcc	7	V
	Output Voltage	Vo	7	٧
	Output Current	lo	25	mA
	Power Dissipation'2	Pc	40	mW
Isolation Voltage ^{*3}		BV	3 750	Vr.m.s.
Operating Ambient Temperature		TA	-40 to +85	°C
Storage Temperature		Tstg	-55 to +125	°C

^{*1} Reduced to 0.3 mA/ $^{\circ}$ C at T_A = 25 $^{\circ}$ C or more.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Low Level Input Voltage	V _{FL}	0		0.8	V
High Level Input Current	Іғн	6.3	10	12.5	mA
Supply Voltage	Vcc	2.7	3.3	3.6	V
TTL (R∟ = 1 kΩ, loads)	N			5	
Pull-up Resistor	RL	330		4 k	Ω

^{*2} Applies to output pin Vo (collector pin). Reduced to 1.5 mW/ $^{\circ}$ C at T_A = 65 $^{\circ}$ C or more.

^{*3} AC voltage for 1 minute at $T_A = 25^{\circ}C$, RH = 60% between input and output. Pins 1-2 shorted together, 3-5 shorted together.



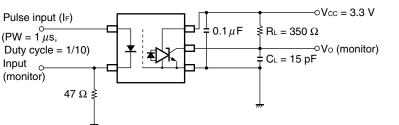
ELECTRICAL CHARACTERISTICS ($T_A = -40 \text{ to } +85^{\circ}\text{C}$, unless otherwise specified)

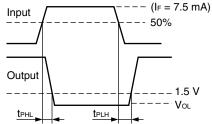
	Parameter	Symbol	Conditions	MIN.	TYP. ^{*1}	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA, T _A = 25°C	1.4	1.65	1.8	٧
	Reverse Current	IR	V _R = 3 V, T _A = 25°C			10	μΑ
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz, T _A = 25°C		30		pF
Detector	High Level Output Current	Іон	Vcc = Vo = 3.3 V, V _F = 0.8 V		1	80	μΑ
			Vcc = Vo = 5.5 V, V _F = 0.8 V		1*2		
	Low Level Output Voltage ³	Vol	$Vcc = 3.3 \text{ V}, I_F = 5 \text{ mA}, I_{OL} = 13 \text{ mA}$		0.2	0.6	٧
			$Vcc = 5.5 \text{ V}, I_F = 5 \text{ mA}, I_{OL} = 13 \text{ mA}$		0.2*2		
	High Level Supply Current	Іссн	Vcc = 3.3 V, I _F = 0 mA, Vo = Open		4	7	mA
			Vcc = 5.5 V, I _F = 0 mA, Vo = Open		5 ^{*2}		
	Low Level Supply Current	Iccl	Vcc = 3.3 V, I _F = 10 mA, Vo = Open		7	10	
			Vcc = 5.5 V, I _F = 10 mA, Vo = Open		9*²		1
Coupled	Threshold Input Current	IFHL	$Vcc = 3.3 \text{ V}, Vo = 0.8 \text{ V}, RL = 350 \Omega$		2.5	5	
	$(H \rightarrow L)$		$Vcc = 5 \text{ V}, Vo = 0.8 \text{ V}, R_L = 350 \Omega$		2.5*2		
	Isolation Resistance	R⊦o	V _{I-O} = 1 kV _{DC} , RH = 40 to 60%, T _A = 25°C	1011			Ω
	Isolation Capacitance	Cı-o	V = 0 V, f = 1 MHz, T _A = 25°C		0.6		pF
	Propagation Delay Time	t PHL	T _A = 25°C		40	75	ns
	$(H \rightarrow L)^{^{*4}}$		$Vcc = 3.3 \text{ V}, \text{ RL} = 350 \Omega, \text{ IF} = 7.5 \text{ mA}$			100	
			$Vcc = 5 \text{ V}, \text{ RL} = 350 \Omega, \text{ IF} = 7.5 \text{ mA}$		37*2		
	Propagation Delay Time	t PLH	T _A = 25°C		45	75	
	$(L \rightarrow H)^{^4}$		$Vcc = 3.3 \text{ V}, \text{ RL} = 350 \ \Omega, \text{ IF} = 7.5 \text{ mA}$			100	
			$Vcc = 5 \text{ V}, \text{ RL} = 350 \Omega, \text{ IF} = 7.5 \text{ mA}$		40*²		
	Rise Time	tr	$Vcc = 3.3 \text{ V}, \text{ RL} = 350 \ \Omega, \text{ IF} = 7.5 \text{ mA}$		20		
			$Vcc = 5 \text{ V}, \text{ RL} = 350 \Omega, \text{ IF} = 7.5 \text{ mA}$		20 ^{*2}		
	Fall Time	tf	Vcc = 3.3 V, RL = 350 Ω , IF = 7.5 mA		5		
			$Vcc = 5 \text{ V}, \text{ RL} = 350 \Omega, \text{ IF} = 7.5 \text{ mA}$		5*²		
	Pulse Width Distortion	tphl-tplh	Vcc = 3.3 V, RL = 350 Ω , IF = 7.5 mA		5	35	
	(PWD)*4		$Vcc = 5 \text{ V}, \text{ RL} = 350 \Omega, \text{ IF} = 7.5 \text{ mA}$		3*2		
	Propagation Delay Skew	tpsk	$Vcc = 3.3 \text{ V}, \text{ RL} = 350 \Omega, \text{ IF} = 7.5 \text{ mA}$			40	
	Common Mode Transient Immunity at High		$V_{\text{CC}} = 3.3 \text{ V}, \text{ R}_{\text{L}} = 350 \Omega, \text{ T}_{\text{A}} = 25^{\circ}\text{C},$ $I_{\text{F}} = 0 \text{ mA}, \text{ Vo} > 2 \text{ V}, \text{ V}_{\text{CM}} = 1 \text{ kV}$	15	20		kV/μs
	Level Output ^{'5}		$V_{\text{CC}} = 5 \text{ V}, \text{ RL} = 350 \ \Omega, \text{ TA} = 25^{\circ}\text{C},$ $I_{\text{F}} = 0 \text{ mA}, \text{ Vo} > 2 \text{ V}, \text{ VcM} = 1 \text{ kV}$		20*2		
	Common Mode C Transient Immunity at Low		$V_{\text{CC}} = 3.3 \ \text{V, R}_{\text{L}} = 350 \ \Omega, \ \text{T}_{\text{A}} = 25^{\circ}\text{C},$ $I_{\text{F}} = 7.5 \ \text{mA, V}_{\text{O}} < 0.8 \ \text{V, V}_{\text{CM}} = 1 \ \text{kV}$	15	20		
	Level Output'5		$V_{CC} = 5$ V, $R_L = 350$ Ω, $T_A = 25$ °C, $I_F = 7.5$ mA, $V_{C} < 0.8$ V, $V_{CM} = 1$ kV		20 ^{°2}		

5



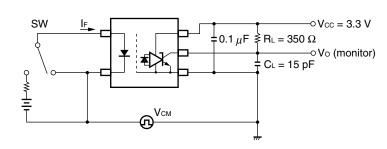
- *1 Typical values at T_A = 25°C
- *2 These values are reference values.
- *3 Because Vol of 2 V or more may be output when LED current input and when output supply of Vcc = 2.6 V or less, it is important to confirm the characteristics (operation with the power supply on and off) during design, before using this device.
- *4 Test circuit for propagation delay time

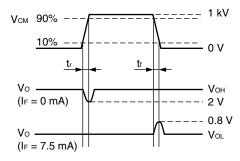




Remark CL includes probe and stray wiring capacitance.

*5 Test circuit for common mode transient immunity





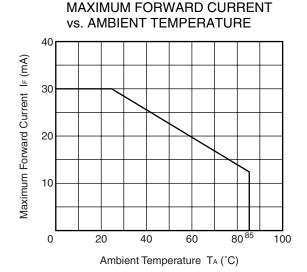
Remark CL includes probe and stray wiring capacitance.

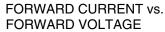
USAGE CAUTIONS

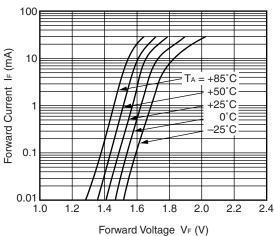
- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of 0.1 μ F is used between Vcc and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.



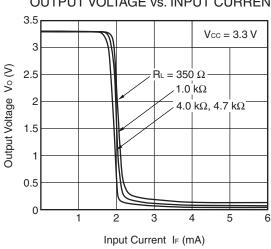
TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)





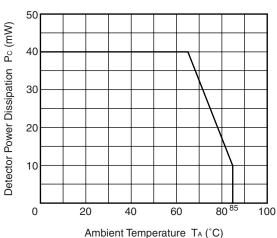


OUTPUT VOLTAGE vs. INPUT CURRENT

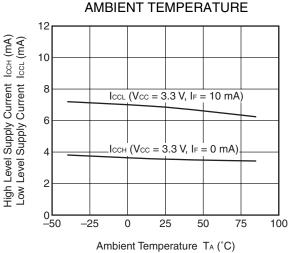


Remark The graphs indicate nominal characteristics.

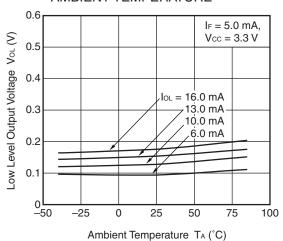




SUPPLY CURRENT vs.

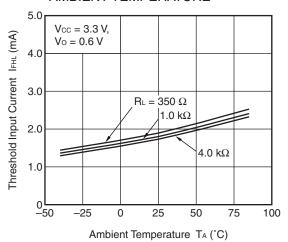


LOW LEVEL OUTPUT VOLTAGE vs. AMBIENT TEMPERATURE

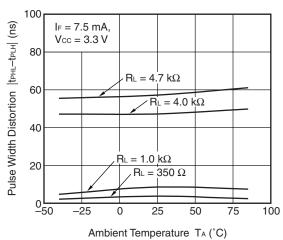




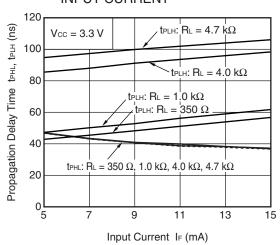
THRESHOLD INPUT CURRENT vs. AMBIENT TEMPERATURE



PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE

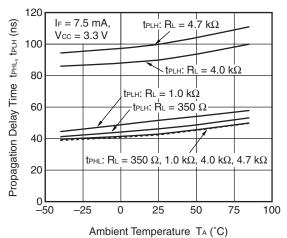


PROPAGATION DELAY TIME vs. INPUT CURRENT

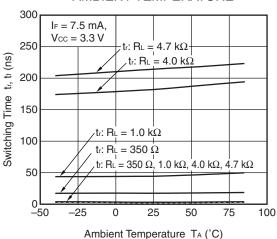


Remark The graphs indicate nominal characteristics.

PROPAGATION DELAY TIME vs. AMBIENT TEMPERATURE

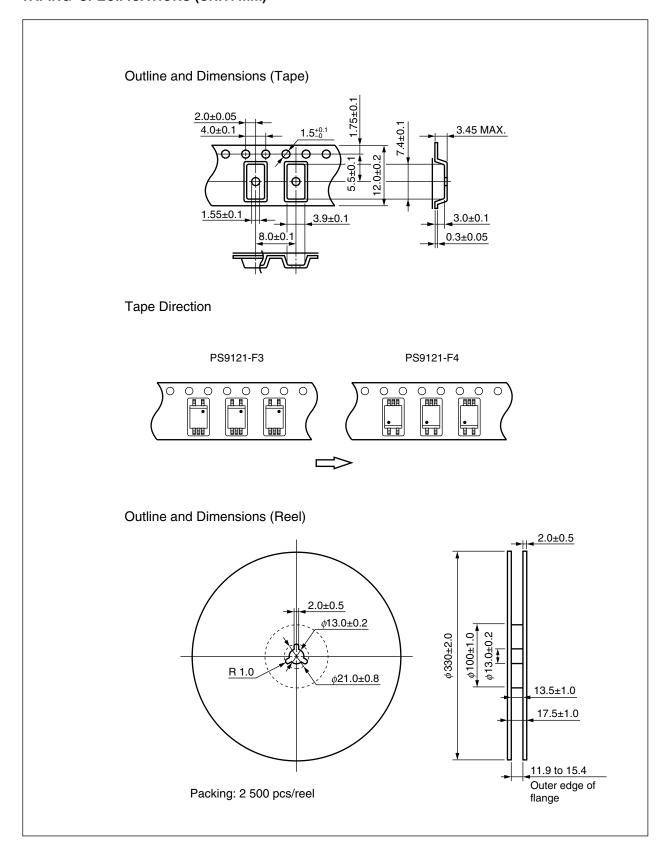


SWITCHING TIME vs. AMBIENT TEMPERATURE

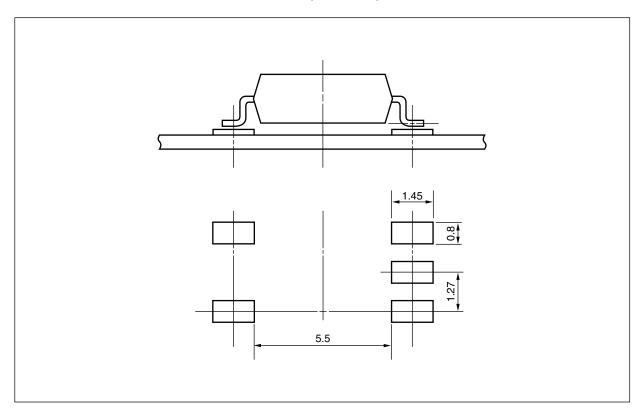




TAPING SPECIFICATIONS (UNIT: mm)



<R> RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)





NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

• Peak reflow temperature 260°C or below (package surface temperature)

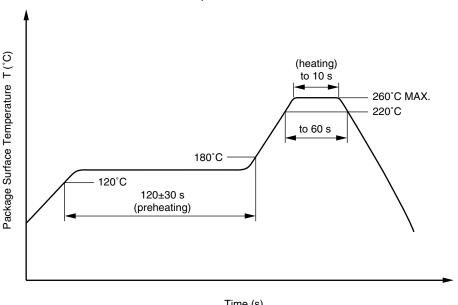
• Time of peak reflow temperature 10 seconds or less • Time of temperature higher than 220°C 60 seconds or less

• Time to preheat temperature from 120 to 180°C 120±30 s Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

 Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

· Preheating conditions 120°C or below (package surface temperature)

· Number of times One (Allowed to be dipped in solder including plastic mold portion.)

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

• Peak Temperature (lead part temperature) 350°C or below • Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(b) Please be sure that the temperature of the package would not be heated over 100°C



(4) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.



<R> SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Speck	Unit
Application classification (DIN EN 60664-1 VDE0110 Part 1) for rated line voltages \leq 300 Vr.m.s. for rated line voltages \leq 600 Vr.m.s.		IV III	
Climatic test class (DIN EN 60664-1 VDE0110)		40/85/21	
Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.5 \times U_{IORM}, P_d < 5 pC$	UIORM Upr	707 1 061	V _{peak} V _{peak}
Test voltage (partial discharge test, procedure b for all devices) $U_{pr}=1.875\times U_{IORM},P_d<5\;pC$	Upr	1 326	V_{peak}
Highest permissible overvoltage	Utr	6 000	V _{peak}
Degree of pollution (DIN EN 60664-1 VDE0110 Part 1)		2	
Clearance distance		>4.2	mm
Creepage distance		>4.2	mm
Comparative tracking index (DIN IEC 112/VDE 0303 Part 1)	СТІ	175	
Material group (DIN EN 60664-1 VDE0110 Part 1)		III a	
Storage temperature range	T _{stg}	-55 to +125	°C
Operating temperature range	TA	-40 to +85	°C
Isolation resistance, minimum value VIO = 500 V dc at TA = 25°C VIO = 500 V dc at TA MAX. at least 100°C	Ris MIN. Ris MIN.	10 ¹² 10 ¹¹	Ω Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Package temperature Current (input current IF, Psi = 0) Power (output or total power dissipation) Isolation resistance	Tsi Isi Psi	150 200 300	°C mA mW
Vio = 500 V dc at T _A = Tsi	Ris MIN.	10°	Ω

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- "Standard": Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots.
- "Special": Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support).
- "Specific": Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems and medical equipment for life support, etc.

The quality grade of NEC Electronics products is "Standard" unless otherwise expressly specified in NEC Electronics data sheets or data books, etc. If customers wish to use NEC Electronics products in applications not intended by NEC Electronics, they must contact an NEC Electronics sales representative in advance to determine NEC Electronics' willingness to support a given application.

(Note)

- (1) "NEC Electronics" as used in this statement means NEC Electronics Corporation and also includes its majority-owned subsidiaries.
- (2) "NEC Electronics products" means any product developed or manufactured by or for NEC Electronics (as defined above).

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Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
- Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.